

KTS-2012UV365

2.0 x 1.25 mm UV LED With Ceramic Substrate



FEATURES

- 2.0 mm x 1.25 mm SMD LED, 0.75 mm thickness
- Low power consumption
- · Wide viewing angle
- Package: 2000 pcs / reel
- Moisture sensitivity level: 1
- RoHS compliant

APPLICATIONS

- Photocatalytic Purification
- · Blood and Counterfeit money detection
- UV curing in nail salon, dental, and poster printing applications
- UV Sensor Light

PACKAGE MATERIALS

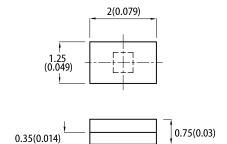
 Material as follows: Package: Ceramics Encapsulating resin: Silicone resin Electrodes: Au plating

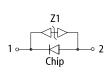
ATTENTION

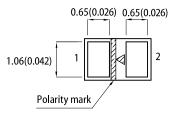
Observe precautions for handling electrostatic discharge sensitive devices

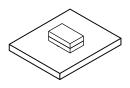


PACKAGE DIMENSIONS



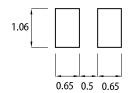






RECOMMENDED SOLDERING PATTERN

(units : mm; tolerance : ± 0.1)



Notes

1. All dimensions are in millimeters (inches).

Tolerance is ±0.25(0.01") unless otherwise noted.
 The specifications, characteristics and technical data described in the datasheet are subject to

change without prior notice. 4. The device has a single mounting surface. The device must be mounted according to the specifications.

SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	Фе(mW) ^[2] @ 20mA		Viewing ^[1] Angle
			Min.	Тур.	201/2
KTS-2012UV365	Ultraviolet (InGaN)	Water Clear	8.6	13	150°

Notes

- 1. 01/2 is the angle from optical centerline where the radiant intensity is 1/2 of the optical peak value
 2. Radiant flux: +/-15%.
- 3. Radiant flux value is traceable to CIE127-2007 standards.

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ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Value	Unit	
Wavelength at Peak Emission I_F = 20mA [Min.]	λ _{peak}	360		
Wavelength at Peak Emission I_F = 20mA [Typ.]		365	nm	
Wavelength at Peak Emission I _F = 20mA [Max.]		370		
Spectral Bandwidth at 50% Φ REL MAX I _F = 20mA [Typ.]	Δλ	10	nm	
Forward Voltage I _F = 20mA [Typ.]	V _F ^[1]	3.3	N	
Forward Voltage I _F = 20mA [Max.]	VF	3.8		
Reverse Current (V _R = 5V) [Max.]	I _R	50	μ A	
Temperature Coefficient of V _F I_F = 20mA, -10°C \leq T \leq 85°C	TCv	-3.0	mV/°C	

Notes:

Forward voltage: ±0.1V.
 Wavelength value is traceable to CIE127-2007 standards.
 Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Parameter	Symbol	Value	Unit
Power Dissipation	P _D	120	mW
Reverse Voltage	V _R	5	V
Junction Temperature	Tj	115	°C
Operating Temperature	T _{op}	-40 to +85	°C
Storage Temperature	T _{stg}	-40 to +85	°C
DC Forward Current	I _F	30	mA
Peak Forward Current	I _{FM} ^[1]	100	mA
Thermal Resistance (Junction / Ambient)	R _{th JA} ^[2]	100	°C/W
Thermal Resistance (Junction / Solder point)	R _{th JS} ^[2]	50	°C/W

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

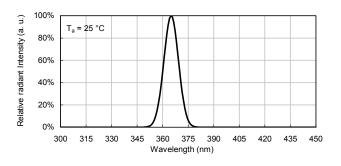
Notes:

1. 1/10 Duty Cycle, 0.1ms Pulse Width. 2. R_{th JA}, R_{th JS} Results from mounting on PC board FR4 (pad size ≥ 16 mm² per pad). 3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

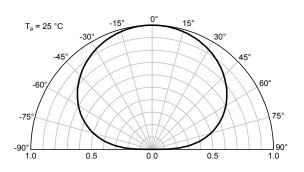
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TECHNICAL DATA

RELATIVE INTENSITY vs. WAVELENGTH



SPATIAL DISTRIBUTION



Forward Current vs. Radiant Flux vs. Forward Voltage Forward Current 50 2.5 T_a = 25 °C T_a = 25 °C Permissible forward current (mA) Radiant flux normalised at 20 mA 40 2 Forward current (mA) 30 1.5 20 1 10 0.5 0 0 2.7 2.9 3.1 3.3 3.5 3.7 0 10 20 30 40 50 Forward voltage (V) Forward current (mA)

ULTRAVIOLET

50

40

30

20

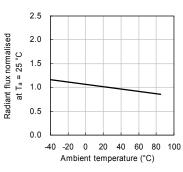
10

0

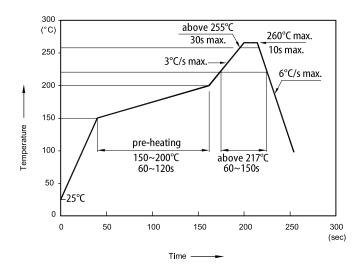
-40 -20 0 20 40



Radiant Flux vs. Ambient Temperature



REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

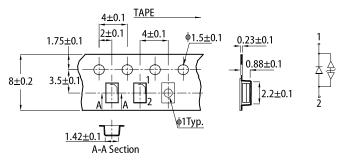


TAPE SPECIFICATIONS (units : mm)

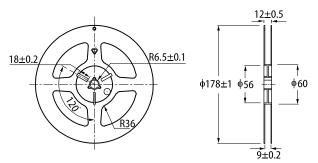
Ambient temperature (°C)

60

80 100



REEL DIMENSION (units : mm)



Notes:

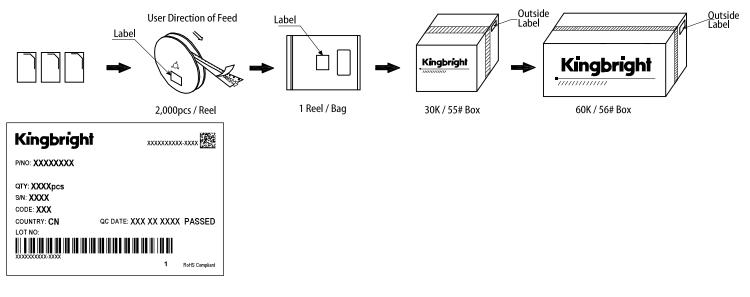
- Notes: 1. Don't cause stress to the LEDs while it is exposed to high temperature. 2. The maximum number of reflow soldering passes is 2 times. 3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

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PACKING & LABEL SPECIFICATIONS



HANDLING PRECAUTIONS

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

- 1. Handle the component along the side surfaces by using forceps or appropriate tools.
- 2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.
- 3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens







As silicone encapsulation is permeable to gases, some corrosive substances such as H₂S might corrode silver 4. plating of lead frame. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.

PRECAUTIONARY NOTES

- The information included in this document reflects representative usage scenarios and is intended for technical reference only. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to 2 the latest datasheet for the updated specifications.
- 3. When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues. The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening
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- 6 All design applications should refer to Kingbright application notes available at http://www.Kingb ight.com/a